

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: S. TSUCHIKAWA, et al.

Application No.: 10/697,116

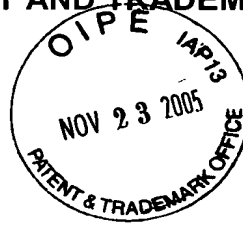
Filed: OCTOBER 31, 2003

For: THERMOSETTING RESIN COMPOSITION AND USE THEREOF

Group AU: 1712

Examiner: Michael J. Feely

Confirm. No.: 8433

**AMENDMENT****Mail Stop: AMEND - FEE**

Commissioner for Patents

P. O. Box 1450

Alexandria, VA 22313-1450

November 23, 2005

Sir:

In response to the Office Action mailed August 24, 2005, please amend the above-identified application as listed in the following, and as set forth on the following pages:

AMENDMENTS TO THE CLAIMS; and

REMARKS are included following the amendments.